

HD74AC175

Quad D-Type Flip-Flop

REJ03D0257-0200Z (Previous ADE-205-377 (Z)) Rev.2.00 Jul.16.2004

Description

The HD74AC175 is a high-speed quad D flip-flop. The device is useful for general flip-flop requirements where clock and clear inputs are common. The information on the D inputs is stored during the Low-to-High clock transition. Both true and complemented outputs of each flip-flop are provided. A Master Reset input resets all flip-flops, independent of the Clock or D inputs, when Low.

Features

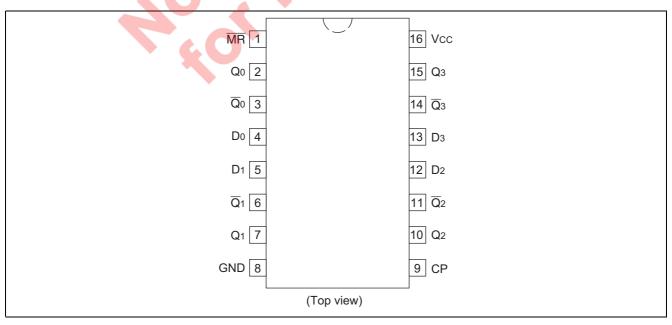
- Edge-Triggered D-Type Inputs
- Buffered Positive Edge-Triggered Clock
- Asynchronous Common Reset
- True and Complement Output
- Outputs Source/Sink 24 mA
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74AC175AFPEL	SOP-16 pin (JEITA)	FP-16DAV	FP	EL (2,000 pcs/reel)
HD74AC175ARPEL	SOP-16 pin (JEDEC)	FP-16DNV	RP	EL (2,500 pcs/reel)
HD74AC175TELL	TSSOP-16 pin	TTP-16DAV	Т	ELL(2,000 pcs/reel)

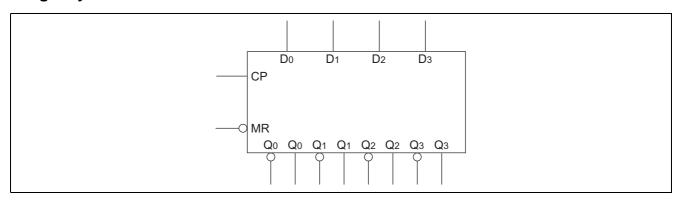
Notes: 1. Please consult the sales office for the above package availability.

2. The packages with lead-free pins are distinguished from the conventional products by adding V at the end of the package code.

Pin Arrangement



Logic Symbol



Pin Names

 $\begin{array}{lll} D_0 \text{ to } D_3 & Data \text{ Inputs} \\ \hline CP & Clock \text{ Pulse Input} \\ \hline MR & Master \text{ Reset Input} \\ \hline Q_0 \text{ to } Q_3 & True \text{ Outputs} \\ \end{array}$

 $\overline{\mathbf{Q}}_0$ to $\overline{\mathbf{Q}}_3$ Complement Outputs

Functional Description

The HD74AC175 consists of four edge-triggered D flip-flops with individual D inputs and Q and \overline{Q} outputs. The Clock and Master Reset are common. The four flip-flops will store the state of their individual D inputs on the Low-to-High clock (CP) transition, causing individual Q and \overline{Q} outputs to follow. A Low input on the Master Reset (\overline{MR}) will force all Q outputs Low and \overline{Q} outputs High independent of Clock or Data inputs. The HD74AC175 is useful for general logic applications where a common Master Reset and Clock are acceptable.

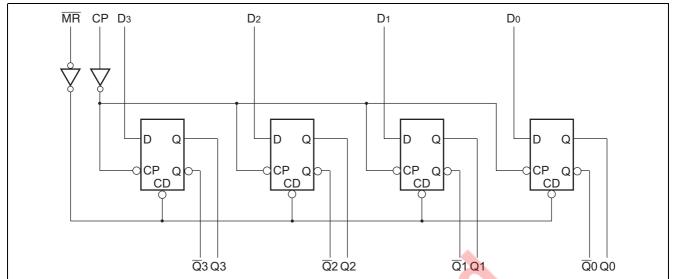
Truth Table

	Inputs		Outputs	
	@ t _n , MR = H		@ t _{n+1}	
Dn		Qn	3)	Q n
L		L		Н
Н		Н		L

H: High Voltage LevelL: Low Voltage Level

t_n: Bit Time before Clock Pulse t_{n+1}: Bit Time after Clock Pulse

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V _{cc}	-0.5 to 7	V	
DC input diode current	I _{IK}	-20	mA	$V_1 = -0.5V$
		20	mA	V _I = Vcc+0.5V
DC input voltage	V _I	-0.5 to Vcc+0.5	V	
DC output diode current	I _{OK}	-50	mA	$V_{O} = -0.5V$
		50	mA	V _O = Vcc+0.5V
DC output voltage	Vo	-0.5 to Vcc+0.5	V	
DC output source or sink current	I _o	±50	mA	
DC V _{cc} or ground current per output pin	I _{CC} , I _{GND}	±50	mA	
Storage temperature	Tstg	-65 to +150	°C	

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Condition
Supply voltage	V _{cc}	2 to 6	V	
Input and output voltage	V_{I}, V_{O}	0 to V _{CC}	V	
Operating temperature	Та	-40 to +85	°C	
Input rise and fall time	tr, tf	8	ns/V	$V_{CC} = 3.0V$
(except Schmitt inputs)				V _{CC} = 4.5 V
V _{IN} 30% to 70% V _{CC}				V _{CC} = 5.5 V

DC Characteristics

Item	Sym- bol	Vcc (V)	7	Га = 25°(C		-40 to 5°C	Unit	Condition
			min.	typ.	max.	min.	max.		
Input Voltage	V _{IH}	3.0	2.1	1.5	_	2.1	_	٧	$V_{OUT} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$
		4.5	3.15	2.25	_	3.15	_		
		5.5	3.85	2.75	_	3.85	_		
	V _{IL}	3.0	_	1.50	0.9	_	0.9		$V_{OUT} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$
		4.5	_	2.25	1.35	_	1.35		
		5.5	_	2.75	1.65	_	1.65		
Output voltage	V _{OH}	3.0	2.9	2.99	—	2.9	—	V	$V_{IN} = V_{IL}$ or V_{IH}
		4.5	4.4	4.49	_	4.4	_		$I_{OUT} = -50 \mu A$
		5.5	5.4	5.49	_	5.4	_		
		3.0	2.58	_	_	2.48	_		$V_{IN} = V_{IL} \text{ or } V_{IH} \qquad I_{OH} = -12 \text{ mA}$
		4.5	3.94		_	3.80			$I_{OH} = -24 \text{ mA}$
		5.5	4.94		_	4.80			$I_{OH} = -24 \text{ mA}$
	V_{OL}	3.0	_	0.002	0.1	_	0.1		$V_{IN} = V_{IL}$ or V_{IH}
		4.5	_	0.001	0.1	_	0.1		I _{OUT} = 50 μA
		5.5	_	0.001	0.1	_	0.1		
		3.0	_	_	0.32	_	0.37		$V_{IN} = V_{IL}$ or V_{IH} $I_{OL} = 12 \text{ mA}$
		4.5	_		0.32	-	0.37		$I_{OL} = 24 \text{ mA}$
		5.5	_	_	0.32	-	0.37		$I_{OL} = 24 \text{ mA}$
Input leakage current	I _{IN}	5.5	_	_	±0.1	_	±1.0	μΑ	$V_{IN} = V_{CC}$ or GND
Dynamic output	I _{OLD}	5.5	_	_		86	-X	mΑ	V _{OLD} = 1.1 V
current*	I _{OHD}	5.5	_	_	-	-75		mΑ	V _{OHD} = 3.85 V
Quiescent supply current	I _{CC}	5.5	_	7	8.0	-0	80	μΑ	$V_{IN} = V_{CC}$ or ground

^{*}Maximum test duration 2.0 ms, one output loaded at a time.

AC Characteristics

			Ta = +25°C C _L = 50 pF		$Ta = -40^{\circ}C \text{ to } +85^{\circ}C$ $C_{L} = 50 \text{ pF}$			
Item	Symbol	V _{cc} (V)*1	Min	Тур	Max	Min	Max	Unit
Maximum clock	f _{max}	3.3	149	_	_	139	_	MHz
frequency		5.0	187	_	_	187	_	
Propagation delay	t _{PLH}	3.3	1.0	9.5	12.0	1.0	13.5	ns
CP to Q _n or Q _n		5.0	1.0	7.0	9.0	1.0	9.5	
Propagation delay	t _{PHL}	3.3	1.0	8.5	13.0	1.0	14.5	ns
CP to Q _n or Q _n		5.0	1.0	6.0	9.5	1.0	10.5	
Propagation delay	t _{PLH}	3.3	1.0	7.5	12.5	1.0	13.5	ns
\overline{MR} to Q_n		5.0	1.0	5.5	9.0	1.0	10.0	
Propagation delay	t _{PHL}	3.3	1.0	8.5	11.0	1.0	12.5	ns
MR to Q _n		5.0	1.0	6.0	8.5	1.0	9.0	

Note: 1. Voltage Range 3.3 is 3.3 V \pm 0.3 V Voltage Range 5.0 is 5.0 V \pm 0.5 V

AC Operating Requirements

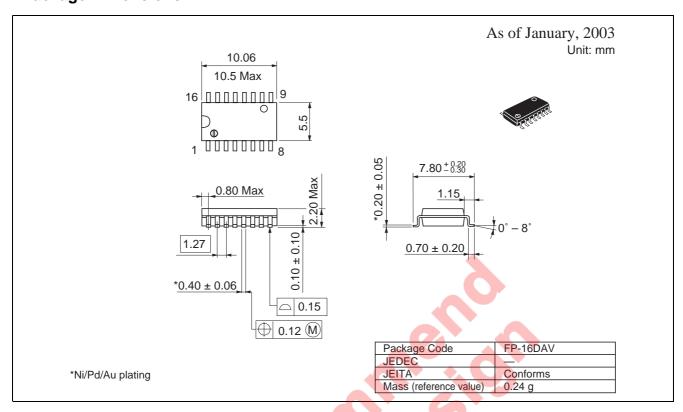
			Ta = +25°C C _∟ = 50 pF		Ta = -40°C to +85°C C _L = 50 pF	
Item	Symbol	V _{cc} (V)*1	Тур	Guarantee	d Minimum	Unit
Set-up time, HIGH or LOW	t _{su}	3.3	2.0	4.5	4.5	ns
D _n to CP		5.0	1.0	3.0	3.0	
Hold time, HIGH or LOW	t _h	3.3	0	1.0	1.0	ns
D _n to CP		5.0	0	1.0	1.0	
CP pulse width HIGH or LOW	t _w	3.3	2.5	4.5	4.5	ns
		5.0	2.0	3.5	3.5	
MR pulse width, LOW	t _w	3.3	2.5	4.5	5.0	ns
		5.0	2.0	3.5	3.5	
Recovery time MR to CP	t _{rec}	3.3	-2.0	0.0	0.0	ns
		5.0	-1.0	0.0	0.0	

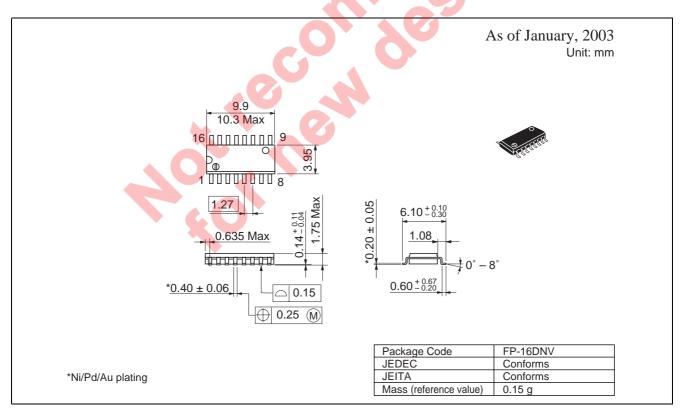
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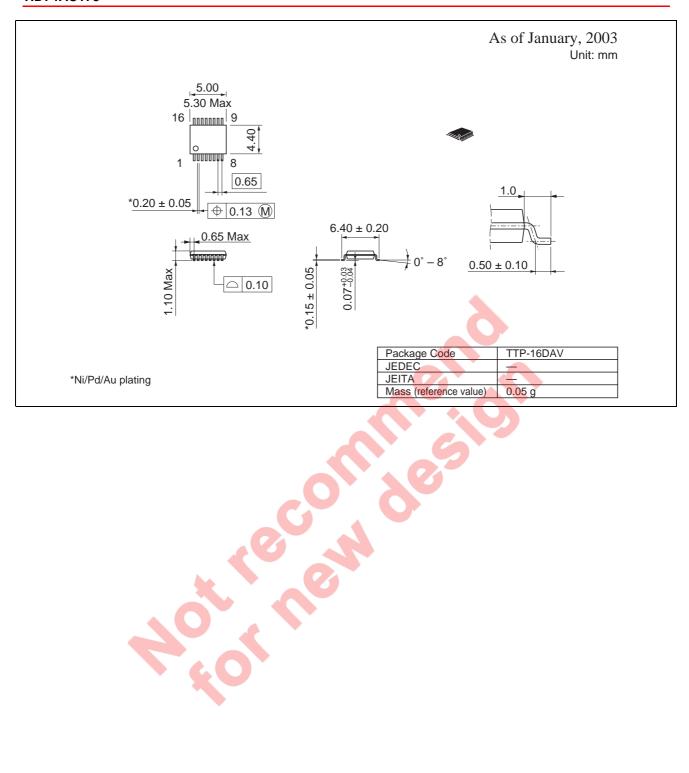
Capacitance

Item	Symbol	Тур	Unit	Condition
Input capacitance	C _{IN}	4.5	pF	V _{CC} = 5.5 V
Power dissipation capacitance	C _{PD}	45.0	pF	V _{CC} = 5.0 V
			6	

Package Dimensions







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